

Pro/E

PDM: Rev:\$

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STATUS: Released Printed: Aug 11, 2007

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PRODUCT NUMBER

SEE SHEET 3

CONNECTOR NOTES:

I. HOUSING MATERIAL: UL 94 V-0 GLASS FILLED HIGH TEMP THERMOPLASTIC POWER CONTACT MATERIAL: COPPER ALLOY SIGNAL CONTACT MATERIAL: COPPER ALLOY

(2) PLATING: (51625-XXXXX STAND OFF 51625-XX001 AND 51625-XX002)

51625-XXXXX Signal Pin:30u"/0.76um Au OVER 50u"/1.27um Ni ON THE CONTACT AREA,

AND 100u"/2.54um SnPb PLATING OVER 50u"/1.27um Ni ON THE TERMINATION SECTION.

Power Pin:30u"/0.76um Au OVER 50u"/1.27um Ni ON THE CONTACT AREA. AND 100u"/2.54um SnPb PLATING OVER 50u"/1.27um Ni ON THE TERMINATION SECTION.

51625-XXXXXLF Signal Pin:30u"/0.76um Au OVER 50u"/1.27um Ni ON THE CONTACT AREA, AND 78u"/2.00um Sn PLATING OVER 50u"/I.27um Ni ON THE TERMINATION SECTION. Power Pin: 30u"/0.76um Au OVER 50u"/1.27um Ni ON THE CONTACT AREA,

AND 78u"/2.00um Sn PLATING OVER 50u"/1.27um Ni ON THE TERMINATION SECTION.

PART NUMBER 51625-XXXXXLF MEETS EUROPEAN UNION DIRECTIVE AND OTHER COUNTRY REGULATIONS AS DESCRIBED IN GS-22-008.

THE HOUSING WILL WITHSTAND EXPOSURE TO 260° PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION WITH A CIRCUIT BOARD.

3. MANUFACTURER'S NAME, P/N. AND DATE CODE TO APPEAR ON THIS SURFACE

4. PRODUCT SPECIFICATION GS-12-149

5. ALL DIMENSIONS ARE BASIC UNLESS OTHERWISE SPECIFIED

6. ALL THROUGH HOLES ARE LOCATED WITH A TRUE POSITION OF 0.004 [0.10]

7. ALL HOLE DIAMETERS ARE FINISHED HOLE SIZE

8. Ø 0.098[2.49] THROUGH HOLES ARE UNPLATED.

9. ∅0.0453±0.0010 [1.151±0.025] DRILLED HOLES PLATED WITH 0.0003 [0.008] MIN SnPb OVER 0.001 [0.03] TO 0.003 [0.08] Cu PLATING TO ACHIEVE A \emptyset 0.040 \pm 0.003 [1.02 \pm 0.07] HOLE.

CONFIDENTIAL

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